

Desoldering tip inner Ø 0.8 mm K series - Thermaltronics K75DT003

Item no. WL37653 **Manufacturer** Thermaltronics
Manufacturer no. K75DT003

K series desoldering tip with 0.8 mm inner diameter for the DS-GUN-3 desoldering gun. The fine bore draws solder from small plated through-holes and tight connections. Working range 350 to 398 °C, lead-free and RoHS compliant.

TECHNICAL DATA



Article authenticity	Original product
Condition of article	New
Country of Manufacture	United States
Execution	ESD (antistatic)
HS-Code	85159080900
Temperature (max.)	398
Weight	0.1 kg

STANDARDS & COMPLIANCE

ESD safe

DESCRIPTION

The K75DT003 desoldering tip with a 0.8 mm inner diameter removes solder from fine through-hole leads and tight connections. It belongs to the Thermaltronics K desoldering tip series for the DS-GUN-3 desoldering gun and works in the 350 to 398 °C range.

Benefits

- Fine inner diameter 0.8 mm (0.03 in) for small vias and tight connections
- Temperature range 350 to 398 °C of the K series
- Lead-free and RoHS compliant

Technical data

Item no. WL37653

Manufacturer item no.	K75DT003
Product series	K desoldering tip series, 350 to 398 °C
Type	desoldering tip
Inner diameter	0.8 mm (0.03 in)
Tip length	13 mm (0.51 in)
Temperature range	350 to 398 °C
Suitable handpiece	DS-GUN-3

Applications

Removing solder from fine plated through-holes and tight through-hole leads during component replacement and repair.

Compatibility and scope of supply

Fits the DS-GUN-3 handpiece and the DS-KIT-3 desoldering kit with TMT-2000S as well as the TMT-2000S station variants. Supplied as a single piece.

RoHS compliant, lead-free, ESD safe. Made in USA.